Application No.: 10/521,141 Docket No.: SONYJP 3.3-1079

IN THE CLAIMS

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- 1. (canceled)
- 2. (currently amended) The method for decorating the surface of a die according to claim 4, in which the molding stepincludes heating the photomask and sticking a heated photomask to a predetermined die.
 - (canceled)
- 4. (currently amended) A method for decorating a surface of a die usable for forming a three-dimensional object by a molding process, said method comprising the steps of:

coating the surface of the die with a photoresist;

molding a photomask into a same shape as a shape of said die which corresponds to a shape of the three-dimensional object;

sticking the photomask molded into said shape to said die coated with the photoresist; and

causing a pattern formed on said photomask to be $\frac{\mbox{\ensuremath{arranged}}}{\mbox{\ensuremath{arranged}}}$ formed onto said die,

in which the die is usable to form the three-dimensional object with the pattern formed thereon by the molding process

wherein said pattern is formed on a surface of the photomask uniformly.

5. (previously presented) The method for decorating the surface of a die according to claim 4, in which the three-dimensional object is a diaphragm of a speaker.

Claims 6.-8. (canceled)

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9. (new) The method for decorating the surface of a die according to claim 4, wherein said pattern is a geometric pattern.

- 10. (new) The method for decorating the surface of a die according to claim 4, wherein said pattern is a grid-like pattern.
- 11. (new) A method for decorating a surface of a die usable for forming a diaphragm of a speaker by a molding process, said method comprising:

coating the surface of the die with a photoresist;

molding a seamless one piece photomask having a pattern thereon into a same shape as a shape of said die which corresponds to a shape of the diaphragm of the speaker;

sticking the molded seamless one piece photomask to said die coated with the photoresist; and

causing the pattern of the molded seamless one piece photomask to be transcribed onto said die,

in which the die is usable to form the diaphragm of the speaker by the molding process such that the diaphragm has a seamless pattern formed thereon which corresponds to the pattern of the photomask.